

View Online at https://aerobasegroup.com/nsn/5910-01-283-7085

Body Style:
Chip type
Reliability Indicator:
Established
Reliability Failure Rate Level In Percent:
0.001
Terminal Length:
Between 0.010 inches and 0.030 inches
Body Length:
Between 0.065 inches and 0.095 inches
Body Width:
Between 0.035 inches and 0.065 inches
Body Height:
Between 0.020 inches and 0.055 inches
Schematic Diagram Designator:
No common or grounded electrode (s)
End Application:
5820-01-221-3440
Insulation Resistance At Maximum Operating Temp:
1000.0 megohms
Capacitance Value Per Section:
18.000 picofarads single section
Nonderated Operating Temp:
Between -55.0 degrees celsius and 125.0 degrees celsius
Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:
0.0 single section
Nonderated Continuous Voltage Rating And Type Per Section:
100.0 dc single section
Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:
-30.0/+30.0 single section
Tolerance Range Per Section:
-5.00/+5.00 percent single section
Case Material:
Ceramic
Insulation Resistance At Reference Temp:
100000.0 megohms
Dissipation Factor At Reference Tempurature In Percent:
0.150
Terminal Surface Treatment:
Solder
Test Data Document:
81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification
format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain

environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).



Terminal Type And Quantity:

2 bonding pad

Specification Data:

81349-mil-c-55681/1 government specification

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

No

Fiig:

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